

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	15	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	40	°C/W

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	DBLS151G DBLS152G DBLS153G DBLS154G DBLS155G DBLS156G DBLS157G	$I_F = 1.5\text{A}, T_J = 25^\circ\text{C}$	V_F	-	1.10	V
	DBLS158G DBLS159G			-	1.25	V
Reverse current @ rated V_R per diode ⁽²⁾		$T_J = 25^\circ\text{C}$	I_R	-	2	μA
		$T_J = 125^\circ\text{C}$		-	500	μA

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION		
ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING
DBLS15xG	DBLS	1,500 / Tape & Reel
DBLS15xGH	DBLS	1,500 / Tape & Reel

Notes:

1. "x" defines voltage from 50V(DBLS151G) to 1400V(DBLS159G)
2. "H" means AEC-Q101 qualified

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

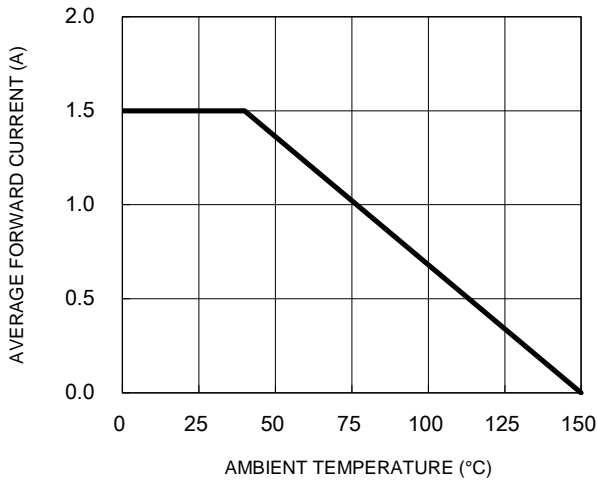


Fig.2 Typical Junction Capacitance

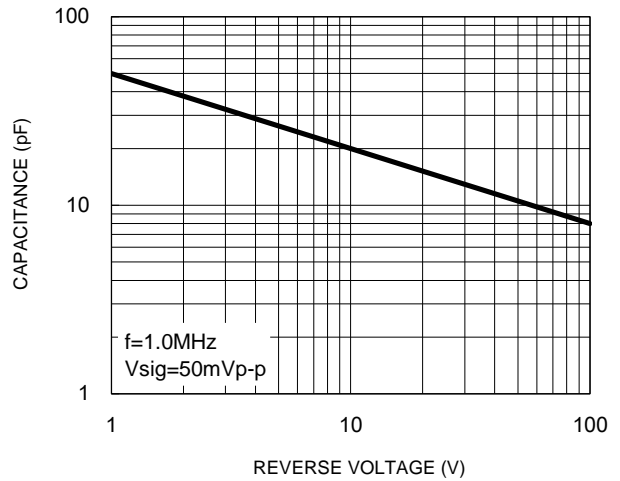


Fig.3 Typical Reverse Characteristics

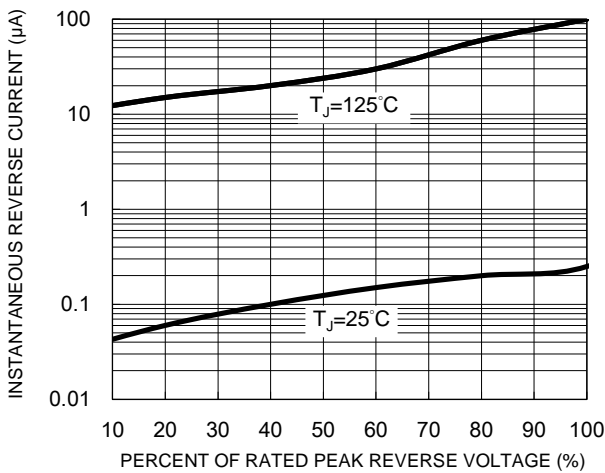


Fig.4 Typical Forward Characteristics

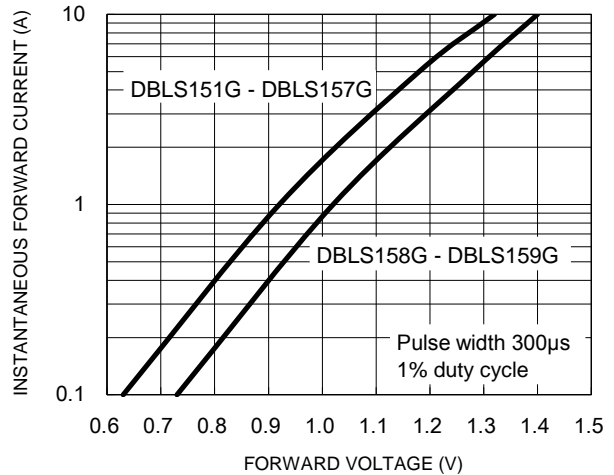
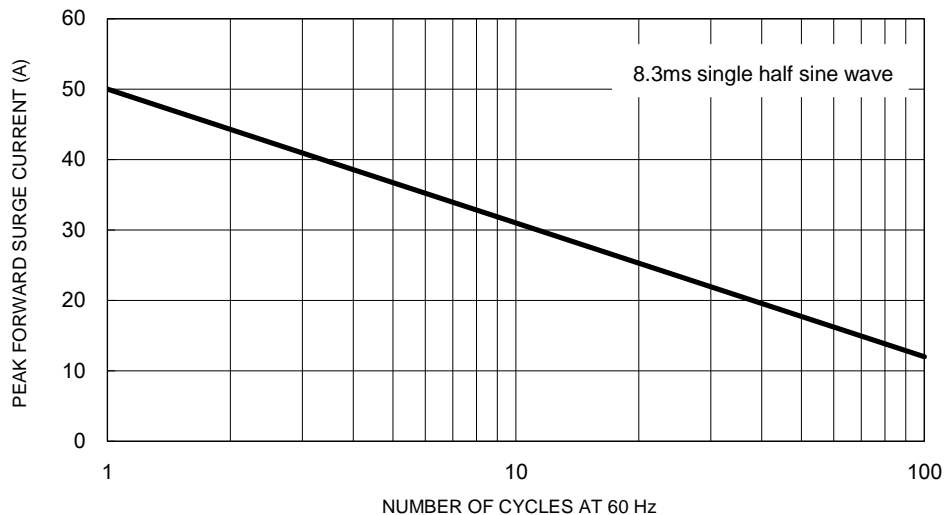
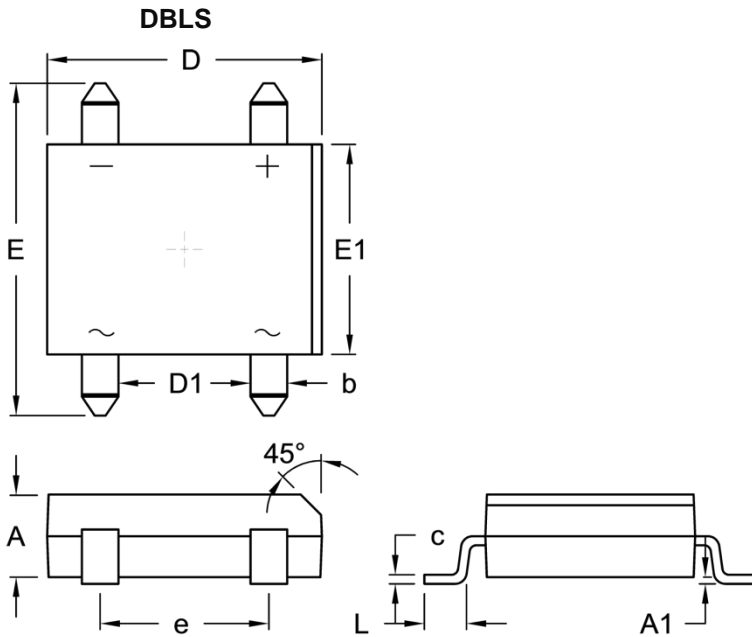


Fig.5 Maximum Non-Repetitive Forward Surge Current

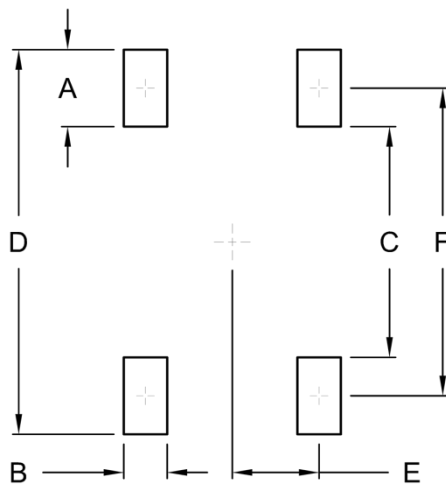


PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.40	2.60	0.094	0.102
A1	0.076	0.330	0.003	0.013
b	1.02	1.20	0.040	0.047
c	0.22	0.33	0.009	0.013
D	8.13	8.51	0.320	0.335
D1	3.90	4.10	0.154	0.161
E	9.80	10.30	0.386	0.406
E1	6.20	6.50	0.244	0.256
e	5.00	5.20	0.197	0.205
L	1.02	1.53	0.040	0.060

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.30	0.091
B	1.30	0.051
C	6.90	0.272
D	11.50	0.453
E	2.60	0.102
F	9.20	0.362

MARKING DIAGRAM



- P/N = Marking Code
- G = Green Compound
- YW = Date Code
- F = Factory Code

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